

Publication Year	2008
Acceptance in OA@INAF	2023-02-15T14:24:08Z
Title	Planck sorption cooler inflight performance prediction report
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Handle	http://hdl.handle.net/20.500.12386/33476
Number	PL-LFI-PST-RP-042



Planck LFI

Planck Sorption Cooler

Inflight Prediction Report

DOC. TYPE: Report

PROJECT REF.: PL-LFI-PST-RP-042 PAGE: I of III, 13

ISSUE/REV.: 1.0 DATE: 14 Aug 2008

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Issue/Rev. No.: 1.0 Date: 14 Aug 2008

Page: ii

CHANGE RECORD

Issue	Date	Sheet	Description of Change	Release
1.0	Aug 2008	All	First Issue of the Document	===



Issue/Rev. No.:

Date: 14 Aug 2008 Page: iii

TABLE OF CONTENTS

T	ABLE OF CONTENTS III	
1	INTRODUCTION AND SCOPE 1	
2	APPLICABLE DOCUMENTS 2	
3	THE REQUIREMENTS ON THE SCS FROM SECTION 4.7 OF AD (1) 3	
	3.1 COOLING REQUIREMENTS (AD1, SEC. 4.7.1) 3.2 COOLING POWER CAPABILITY (AD1, SEC. 4.7.2) 3.3 TEMPERATURE STABILITY (AD1, SEC. 4.7.3) 3.4 LIFETIME (AD1, SEC. 4.7.4) 3.5 RELEVANT EXTRA INFORMATION FROM AD1 3.5.1 Interface Temperatures to Ensure Cooling Capability(Sec. 4.3 of AD1) 3.5.2 Effect of Warm Radiator Temperature on the Cooling capability (from Sec 5.9.3.1 of AD1)	3 4 5
4	BEST ESTIMATE OF HEAT LOADS ON LVHX1 AND LVHX2 8	
5	SCS PERFORMANCES 9	
	5.1 PERFORMANCE SUMMARY	
6	CONCLUSIONS 11	
	ANNEX-1 PL-I FL-IPL-RFD-010	12



Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 1

1 INTRODUCTION AND SCOPE

The scope of this document is to show the predictions of inflight performance of the Sorption Cooler subsystem as a consequence of analysis, the Subsystem Testing and Unit testing, and the Planck System Level Thermal Vacuum, Thermal Balance, and Cryogenic verification campaigns. These predictions will be compared with those in Section 4.7 of (AD1) as required by ESA to demonstrate that the Sorption Cooler will operate as expected in the mission.



Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 2

2 APPLICABLE DOCUMENTS

[AD 1] Planck Sorption Cooler ICD, PL-LFI-PST-ID-002, Is.3.1, 20/7/04. Annex of the LFI IID-B, SCI-PT-IIDB-LFI-04142, Is.3.1, 20/7/04

[AD 2] Planck Instrument Flight Acceptance Review (IFAR) Procedure, SCI-PT-51537, Is.1/Rev1, 9/6/08

Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 3

The Requirements on the SCS from Section 4.7 of AD (1)

In this section the requirements given in the Planck Sorption Cooler ICD, PL-LFI-PST-ID-002, Is.3.1, 20/7/04, Section 4.7 are reproduced.

3.1 COOLING REQUIREMENTS (AD1, Sec. 4.7.1)

Table 4.7-1 Total Cooling Requirements

	Power (mW)
HFI 18K	190
LFI 20K	796
TOTAL	986

3.2 COOLING POWER CAPABILITY (AD1, SEC. 4.7.2)

(Accounts for parasitics from active and redundant coolers)

(For a TMU Total Input Power of ≤ 470 W*)

Cryogenic Heat Load		Operating Point
LVHX1	LVHX2	Temperatures of TMU heat transfer components (LVHX1, LVHX2, PC3, PC2, PC1, SCC)
≥190 mW	≥796 (1) mW	Maximum Flight Allowable Temperatures, Operating, per 4.3.1.1 and 4.3.1.2

⁽¹⁾ Accounts for 150 mW allocated and agreed to by LFI, to implement PID at LVHX2 interface per TSA (near LVHX2) to a < 100 mK fluctuation level. This 150 mW are assuming a spacecraft radiator temperature stability of 6K; 2K; 1K (see 5.9.3.1)

3.3 TEMPERATURE STABILITY (AD1, Sec. 4.7.3)

IASF(Bo)/INAF



Issue/Rev. No.: 1.0 Date: 14 Aug 2008

Date: 14 Aug 2008 Page: 4

Interface	Temperature ⁽²⁾ Fluctuation (maximum – minimum), Over TMU Operating Period ⁽¹⁾ (@ ≤ 470 W TMU Input Power)
LVHX1	≤0.45 K
LVHX2	≤0.1 K

Notes: 1. TMU Operating Period defined in 4.3.2

(2) Temperature is measured on LVHX1 and LVHX2, and reported for the condition of zero attached thermal mass. These fluctuations are assuming a spacecraft radiator temperature stability of 6K; 2K; 1K (see 5.9.3.1)

3.4 LIFETIME (AD1, SEC. 4.7.4)

The SCS shall be capable of operating 6 months before launch (3 months at JPL + 3 months for Europeans operations) and 18 months on-orbit.

The requirement above is applicable to a single Sorption Cooler (either the nominal or redundant) of the Sorption Cooler Subsystem.

Note that this requirement has been the subject of a Request for Waver that has been accepted by both LFI, HFI and by ESA Project. PL_LFI_JPL_RFD_010 entitled Planck SCS TMU limited life and post regeneration power. The acceptance of the request for waver allows the life of a sorption cooler to be extended by regeneration of its hydride beds in orbit. The RFW is attached as Annex-1.



Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 5

3.5 RELEVANT EXTRA INFORMATION FROM AD1

The requirements reproduced in Secs. 3.1 to 3.4 quote other sections of AD1 for further information, and these sections of AD1 are reproduced below for completeness.

3.5.1 Interface Temperatures to Ensure Cooling Capability(Sec. 4.3 of AD1)

4.3.1.1 HFI Cooling Requirements

The table gives the estimated HFI cooling requirements at 18K +1.02K/-0.5K, including all parasitics and 4K cooler pre-cooling. Margins originating from precooling temperature less than 60K, will be discussed jointly by JPL and the two instruments teams and managed by the LFI Project Manager.

HFI Cooling Requirements (at 60K environment)

	Power (mW)
18K cooling	190

4.3.1.2 LFI Cooling Requirements

The table gives the estimated LFI Cooling requirements, including HFI parasitics intercepted at a temperature of 20K (+2.5K/-2.5K). Margins originating from precooling temperatures less than 60K, will be discussed jointly by JPL and the two instrument teams and managed by the LFI Project Manager.

LFI Cooling Requirements (at 60K environment)

	Power (mW)
20K cooling (including TSA)	796

Issue/Rev. No.: 1.0 Date: 14 Aug 2008

Page: 6

3.5.2 Effect of Warm Radiator Temperature on the Cooling capability (from Sec 5.9.3.1 of AD1)

5.9.3.1 Radiator Temperature Stability

In addition to holding the average interface temperature within the range specified in Table 5.7.3, the radiator interface will also maintain the following levels of temperature stability peak to peak under the absorbing compressor elements adjacent to the cooling compressor element (at outer shell interface on top of the heat-pipes):

First adjacent element: 8.4 KNext adjacent element: 5.2 K

Next most adjacent element: 5.2 K

[Note: For example, in the case where the 6 elements of the operating cooler of Figure 5.9.3-2 are performing the following (Table 4.4.1-1) functions,

- Element 1 (Heatup)
- Element 2 (Desorbing)
- Element 3 (Cooling)
- Element 4 (Absorbing)
- Element 5 (Absorbing)
- Element 6 (Absorbing),

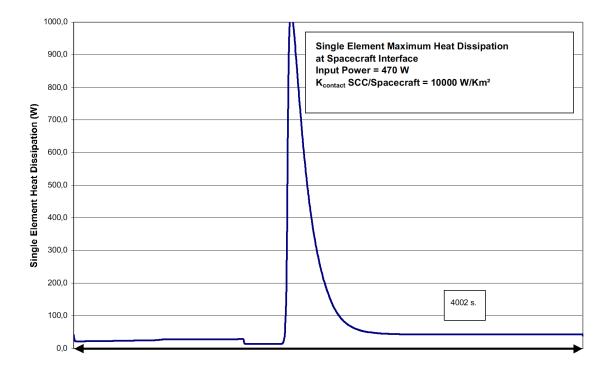


Fig. 5.9.3-2 Variation of the heat loading at the Radiator Interface (single bed)



Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 7

Of course, the element operation sequence is cyclic, and the spatial location of the cooling element and adjacent elements will shift with the cycle period identified in section 4.3.2.

The assumptions taken on the radiator temperature stability to evaluate the temperature stability at HFI and LFI cold end interfaces were optimistic wrt the actual radiator design. Therefore, the impact on HFI and LFI will be .

- HFI: added temperature fluctuation: +160 mK (see 4.7.3)

- LFI: added required power for the TSA: + 53 mW (see paragraph 4.7.2)

Issue/Rev. No.: 1.0 Date: 14 Aug 2008

Date: 14 Aug 2008 Page: 8

4 Best Estimate of Heat Loads on LVHX1 and LVHX2

LFI	Current Estimates values in mW	Comments	HFI	Current Estimates values in mW	Comments
70-44-30 GHz FEMs	344,8	Based on measured dissipation values for each of the 11 FEM			
44 WG's Including Upper and Lower Supports	227,0	Derived from RAA Thermal Model			
LFI Harness	8,0	Estimate for the LFI Cyroharness			
Radiant	2,0	Derived from RAA Thermal Model			
LFI Struts	23,0	Derived from RAA Thermal Model			
PID in SCS for LFI 150,0		Agreed dissipation between LFI and JPL with no consideration of a lower performance radiator			
LFI Total 754,8		Compare to the requirement with a 60K interface of 798 mW	HFI Total	190,0	Allocation to HFI
Heater added to LFI FPU 20,0		Load is on LVHX2. Heaters required to ensure telescope outgassing products do not condense on LFI/HFI. The maximum parasitic load of 20 mW from the sum of two heaters (nominal and redundant			
Thermal blanket added to LFI FPU against stray-light 40,0		Load is on LVHX2.This blanket is in the configuration but heat load is understood to be a worst case.			
Total Load on LVHX2 814,8		See conditions in text below table	Total Load on LVHX1	190,0	

Table 4.1 Best Estimates of Heat Loads on the Cold Ends of an operating Sorption Cooler with an interface temperature of 60K

In Table 4.1 is given the breakdown of the actual best estimates of the heat loads on an operating cooler sorption cooler assuming a 60 K interface temperature. Note that while LFI would be inside the heat loads

IASF(Bo)/INAF



Issue/Rev. No.: 1.0 Date: 14 Aug 2008

Page: 9

agreed for the design of the Sorption Cooler, the actual heat load on LVHS2 is higher because of the System Level needs that became visible late in the development program.

These extra heat loads are on LVHX2 and are:-

- 20mW of parasitic heat load due to the need of the system to add heaters to the LFI FPU to ensure
 that during the out-gassing activity on the telescope LFI and HFI remain at temperatures high
 enough to exclude the possibility of condensation of the out-gassing products occurring on their
 surfaces
- 40mW of parasitic heat load derived from an extra thermal blanket that has been attached to LFI to eliminate stray-light. The need for this addition was agreed between both LFI and HFI.

Thus the heat load on LVHX2 exceeds the requirement by 19mW which, depending on the actual performance of the warm radiator could be further increased by 53mW (see Sec. 3.5.2) through increased dissipation of the TSA, to 72mW.

5 SCS Performances

5.1 Performance summary

The following SCS performances have been evaluated at the end of the integration and test campaign of the Planck Satellite.

Doufoumonoo	В	OL	EOL		
Performance	WR T (K) PC3C T (K)		WRT(K)	PC3C T (K)	
Parameter	270	47	273	48	
LVHX1 T (K)	17	'.1 K	17.5		
LVHX1 \Delta T (K)	0.4	45 K	0.45 K		
TSA T (K)	18	5.6 K	18.6 K		
TSA ΔT (K)	0.	1 K	0.1 K		
Heat Lift (W)	1.050 W		1.050		
Input Power (W)	305 W	(TMU)	470 W (TMU)		
Cycle Time	10)50 s	525 s		

Table 5-1 SCS Performance Summary

5.2 LIFETIME PERFORMANCE

Based on the results of the PFM2 testing results the estimated lifetime for the two SCS systems are:

IASF(Bo)/INAF



Issue/Rev. No.:

Date: 14 Aug 2008 Page: 10

Nominal (FM2) 15.5 months

Redudant (FM1) 13.5 months



Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 11

6 Conclusions

The results of the SCS TV/TB Test Campaigns (PFM1 and PFM2) show that SCS N & R performances are in agreement with requirements.

Only exceptions concern Cold End T fluctuations that are exceeded due to gravitational orientation as was expected according to JPL document D-46302, 01/06/2008, "Planck Sorption Cooler Two-Phase Flow Summary".



Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 12

ANNEX-1 PL-LFI-JPL-RFD-010

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			Request for Deviation					DOC.: PL-LFI-JPL-RFD-010 ISSUE / REV.: 1/1		
1 PROGE	RAM : Hershel-Planck									
Plance SCS							DA	TE: 10 Oct	ober 2006 PA	GE 1 OF
4 TITLE :	Planck SCS TMU Limit	ed Life	and Post-R	egeneration F	Power Incre	ase				
5 OTHER ☑ YES	SYSTEMS/CI'S AFFECTE		RECURRIN	IG DEVIATION	□ NO	7 BA	SELINE AFFE	ECTED		
CONTR	ROLLED DOCUMENTS/	SPEC A	AFFECTED							
SPEC/I	OC. NUMBER		ISSUE/ REV.	DATE		Т	TITLE		PARAGE	
PL-LFI-P	ST-ID-002	11,00	3.1	20Jul04	Planci S	orption	Cooler IC	CD	4.32	
								10 - 00		
	ON COST/PRICE reflects as-built config	IF.	FECT ON DI APPROVED DISAPPROV		EDULE	11	QTY	12 EFFEC		PPORT I
increase.	ooling, at worst case the								time, with redu	
The lifetime	PICATION / REASON of imitation is a function ration process, it comes ies and an attendant incompany of the company of the com	at the prease in	rice of incr	eased cooler hermal condu	operating p	ower, du	e to the pro	duction of n	cont.s	gas gap
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Issue/Rev. No.: 1.0

Date: 14 Aug 2008 Page: 13

	2	DOC.: ISSUE / REV.:	
	121		
1 PROGRAM:	Request for Deviation		
	•		
3 DESCRIPTION		DATE:	PAGE 2 OF
JUSTIFICATION / REASON	N egrate the two JPL NCRs, PL-LFI-JPL-NCR-001 and PL-LFI-		
ssocaiated with PL-LFI-JPL-N ne process of regeneration mu upport to develop optimized so	gas-gap contamination due to the regeneration process, whic CR-001. JPL has stated that with the two sorption coolers the st be a part of the spacecraft capability as some mission scen orption cooler operations to maximize cooler lifetime. This sul will be done under the supervision of Gianluca Morante.	mission requirer arios will require	nents can be met, but it. JPL will provide